	IRCH					March 19
-	6324L grated L	oad Switch				
Genera	al Descriptio	on		Features		
Fairchild technolo especia provide are par switch a	d's proprieta ogy. This illy tailored to superior swit ticularly suite	bad Switches are p ary, high cell d very high densit o minimize on-state tching performance. ed for low voltage here low conductior d.	ensity, DMOS ty process is resistance and . These devices high side load	V _{DROP} =0.3V @ High density V _{ON/OFF} Zener >6KV Humar SuperSOT [™] -	 V_{IN}=12V, I_L=1A, V_{ONOF} V_{IN}=5V, I_L=1A, V_{ONOF} cell design for extreme protection for ESD rug Body Model. 6 package design usir mal and electrical capa 	_F =1.5 to 8V. ely low on-resistanc ggedness. ng copper lead fran
Į	," .					
SOT	-23	SuperSOT [™] -6	SuperSOT [™] -8	SO-8	SOT-223	SOIC-16
			Vin,R1 4		Vout,C1	
Sup	^{pin 1} erSOT [™] -	-6	0N/0FF 5 R1,C1 6		Vout,C1	
Absolu	erSOT™		0N/0FF 5 R1,C1 6	Application Circuit	Vout,C1	
Absolu Symbol	erSOT [™] ute Opera	ting Range ⊤,	ON/OFF 5	Application Circuit	Vout,C1 Vout,C1 N ON/OFF R2	
Absolı Symbol V _{IN}	erSOT TM - ute Opera Parameter Input Voltag	ting Range ⊤,	ON/OFF 5	Application Circuit	Vout,C1 Vout,C1 R2 FDC6324L	
Absolu Symbol	erSOT TM - ute Opera Parameter Input Voltag ON/OFF Vo	ting Range т, e Range	ON/OFF 5 R1,C1 6 See	Application Circuit	Vout,C1 Vout,C1 R2 FDC6324L 3 - 20	
Absoli Symbol V _{IN} V _{ONOFF}	erSOT TM - ute Opera Parameter Input Voltag ON/OFF Vo	<mark>iting Range</mark> т, le Range ltage Range nt @ V _{DROP} =0.5V - Co	ON/OFF 5 R1,C1 6 See	Application Circuit	Vout,C1 Vout,C1 N O ON/OFF R2 FDC6324L 3 - 20 1.5 - 8	
Absoli Symbol V _{IN} V _{ONOFF}	erSOT TM - ute Opera Parameter Input Voltag ON/OFF Vo Load Currer	<mark>iting Range</mark> т, le Range ltage Range nt @ V _{DROP} =0.5V - Co	on/off 5 R1,C1 6 See $a = 25^{\circ}C$ unless otherwis intinuous (Note 1)	Application Circuit	Vout,C1 Vout,C1 R2 FDC6324L 3 - 20 1.5 - 8 1.5	
Absoli Symbol V _{IN} V _{ONOFF} I _L	erSOT TM ute Opera Parameter Input Voltag ON/OFF Vo Load Currer Maximum P	t ing Range T, le Range litage Range nt @ V _{DROP} =0.5V - Co	ON/OFF 5 $R1,C1 6$ Sec $R1,C1 6$ Sec Sec Sec $R1,C1 6$ Sec	Application Circuit	Vout,C1 Vout,C1 N ON/OFF R2 FDC6324L 3 - 20 1.5 - 8 1.5 2.5	Un
Absolu Symbol V _{IN} V _{ONOFF} I _L P _D	erSOT TM - ute Opera Parameter Input Voltag ON/OFF Vo Load Currer Maximum P Operating an Electrostatic	ting Range T Re Range Mage Range Int @ V _{DROP} =0.5V - Co Power Dissipation Ind Storage Temperat	ON/OFF 5 $R1,C1 6$ Sec $R1,C1 6$ Sec Sec Sec $R1,C1 6$ Sec	e noted	Vout,C1 Vout,C1 R2 FDC6324L 3 - 20 1.5 - 8 1.5 2.5 0.7	
Absolu Symbol V _{IN} V _{ONOFF} IL T _J ,T _{STG} ESD	erSOT TM - ute Opera Parameter Input Voltag ON/OFF Vo Load Currer Maximum P Operating an Electrostatic	ting Range Range Itage Range Itage Range Mut @ V _{DROP} =0.5V - Co Power Dissipation Ind Storage Temperat Discharge Rating MI of/1500Ohm)	o N/o FF 5 R1,C1 6 See a = 25°C unless otherwis intinuous (Note 1) - Pulsed (Note 1 & 3) (Note 2a) ture Range	e noted	Vout,C1 Vout,C1 R2 FDC6324L 3 - 20 1.5 - 8 1.5 2.5 0.7 -55 to 150	
Absolu Symbol V _{IN} V _{ONOFF} IL T _J ,T _{STG} ESD	erSOT TM- ute Operation Parameter Input Voltag ON/OFF Vo Load Currer Maximum P Operating at Electrostatic Model (100p	ting Range Range Itage Range Itage Range Mut @ V _{DROP} =0.5V - Co Power Dissipation Ind Storage Temperat Discharge Rating MI of/1500Ohm)	o N/o FF 5 R1,C1 6 $a = 25^{\circ}$ C unless otherwis ontinuous (Note 1) - Pulsed (Note 1 & 3) (Note 2a) ture Range IL-STD-883D Human Bc	e noted	Vout,C1 Vout,C1 R2 FDC6324L 3 - 20 1.5 - 8 1.5 2.5 0.7 -55 to 150	Un
Absolu Symbol V _{IN} V _{ONOFF} I _L P _D T _J ,T _{STG} ESD THERMA	erSOT TM- ute Operat Parameter Input Voltag ON/OFF Vo Load Currer Maximum P Operating at Electrostatic Model (100p L CHARACTE Thermal Re	ting Range T Re Range Nage Range Nage Range Nage Range Nage Range Nage Range Range Rating MI Discharge Rating MI Discharge Rating MI Discharge Rating MI Discharge Rating MI	ON/OFF 5 R1,C1 6 See A = 25°C unless otherwis Intinuous (Note 1) - Pulsed (Note 1 & 3) (Note 2a) ture Range IL-STD-883D Human BC Ambient (Note 2a)	e noted	Vout,C1 Vout,C1 N ON/OFF R2 FDC6324L 3 - 20 1.5 - 8 1.5 2.5 0.7 -55 to 150 6	

Electrical Characteristics (T _A = 25°C unless otherwise noted)								
Symbol	Parameter	Conditions	Min	Тур	Max	Units		
OFF CHA	RACTERISTICS							
I _{FL}	Forward Leakage Current	$V_{IN} = 20 \text{ V}, V_{ONOFF} = 0 \text{ V}$			1	μA		
I _{rl}	Reverse Leakage Current	$V_{IN} = -20 \text{ V}, V_{ONOFF} = 0 \text{ V}$			-1	μA		
ON CHAR	ACTERISTICS (Note 3)							
V _{IN}	Input Voltage		3		20	V		
V _{ON/OFF}	On/Off Voltage		1.5		8	V		
VDROP	Conduction Voltage Drop @ 1A	$V_{IN} = 10 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$		0.135	0.2	V		
		$V_{IN} = 5 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$		0.215	0.3			
I _L	Load Current	$V_{DROP} = 0.2 \text{ V}, V_{IN} = 10 \text{ V}, V_{ONOFF} = 3.3 \text{ V}$	1			А		
		$V_{\text{DROP}} = 0.3 \text{ V}, V_{\text{IN}} = 5 \text{ V}, V_{\text{ONOFF}} = 3.3 \text{ V}$	1			1		

Notes:

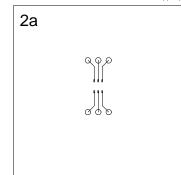
1. V_{IN} =20V, V_{ONOFF} =8V, V_{DROP} =0.5V, T_A =25°C

2. R_{p.h} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{p.k} is guaranteed by design while R_{pCA} is determined by the user's board design.

 $P_D(t) = \frac{T_J - T_A}{R_{\text{BJ}} A(t)} = \frac{T_J - T_A}{R_{\text{BJ}} C^+ R_{\text{BCA}}(t)} = I_D^2(t) \times R_{DS(ON)@T_J}$

Typical $R_{_{BJA}}$ for single device operation using the board layouts shown below on FR-4 PCB in a still air environment:

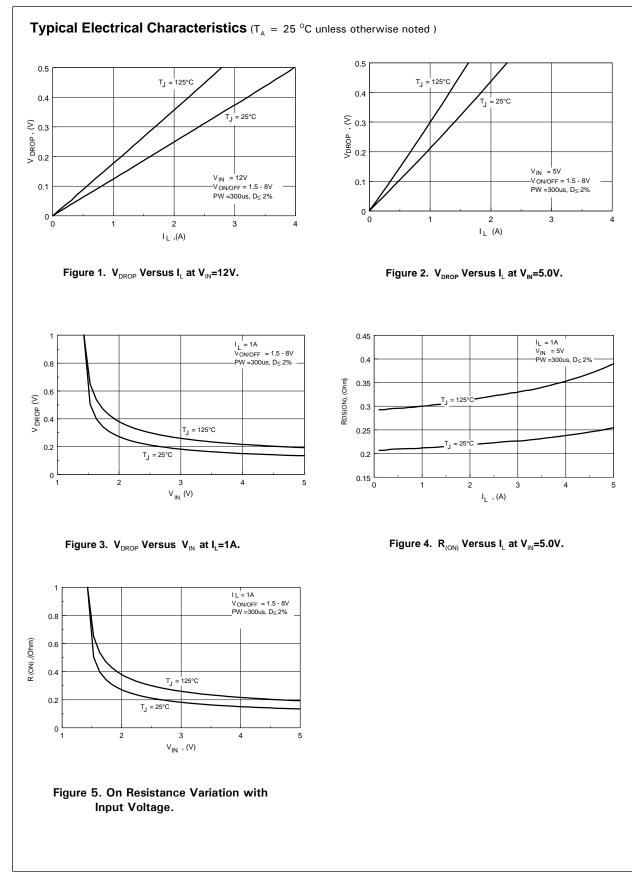
a. 180°C/W when mounted on a 2oz minimum copper pad.



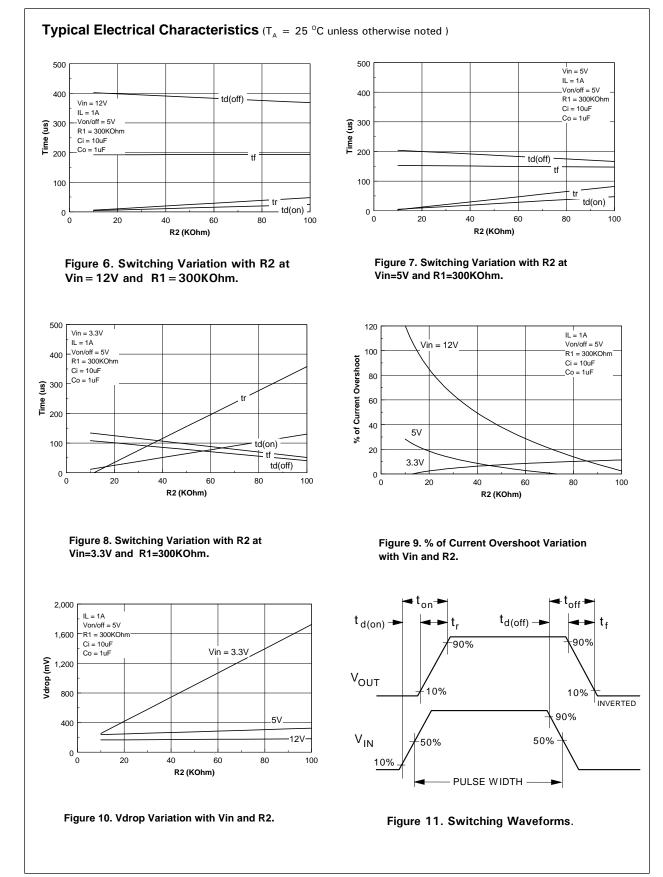
Scale 1 : 1 on letter size paper

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%

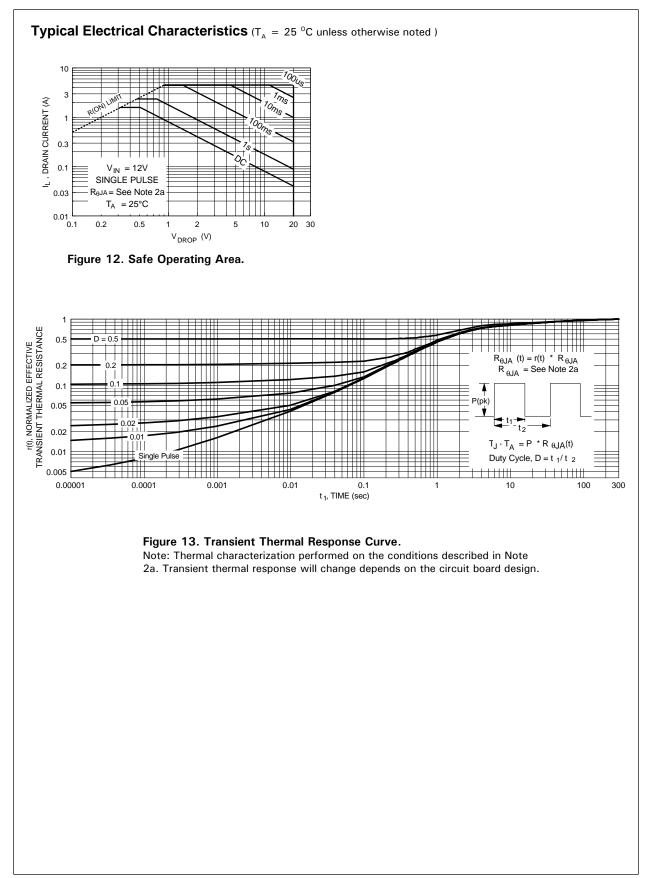
FDC6324L Rev. D



FDC6324L Rev.D

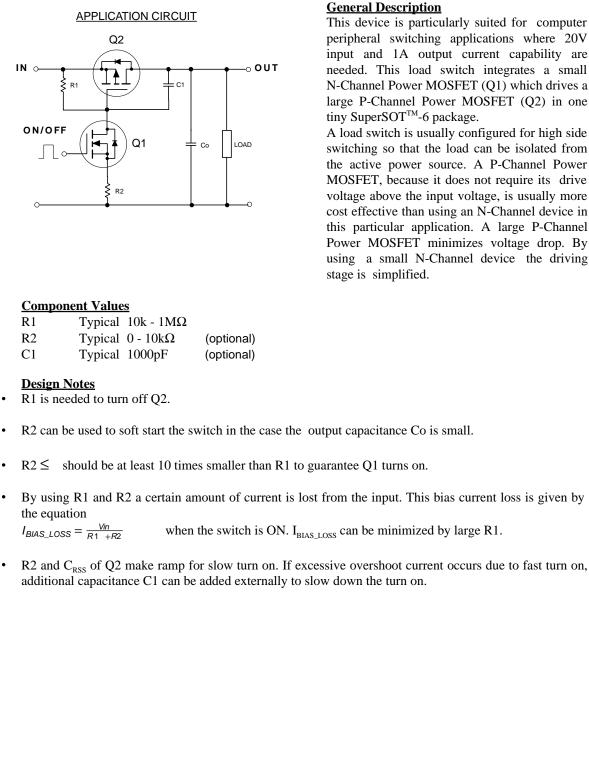


FDC6324L Rev. D



FDC6324L Rev. D

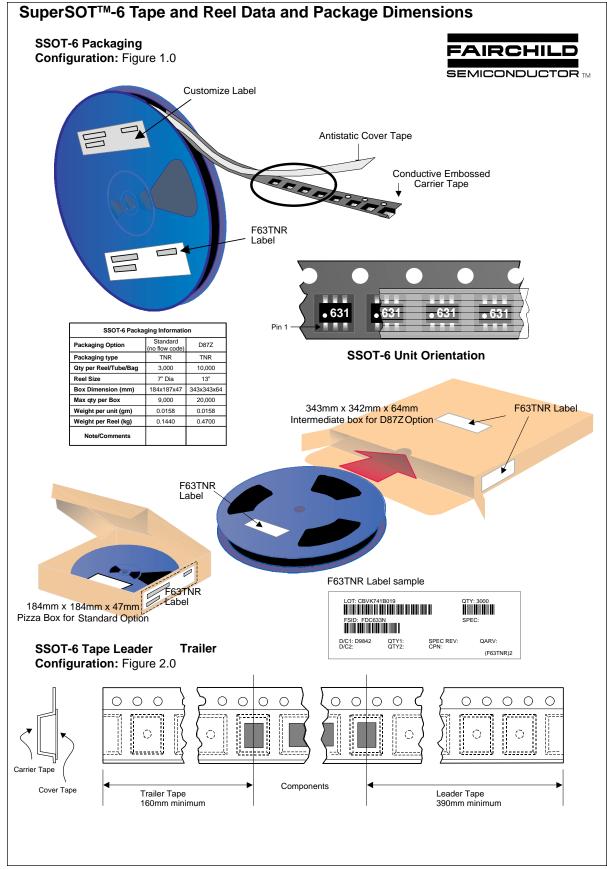
FDC6324L Load Switch Application



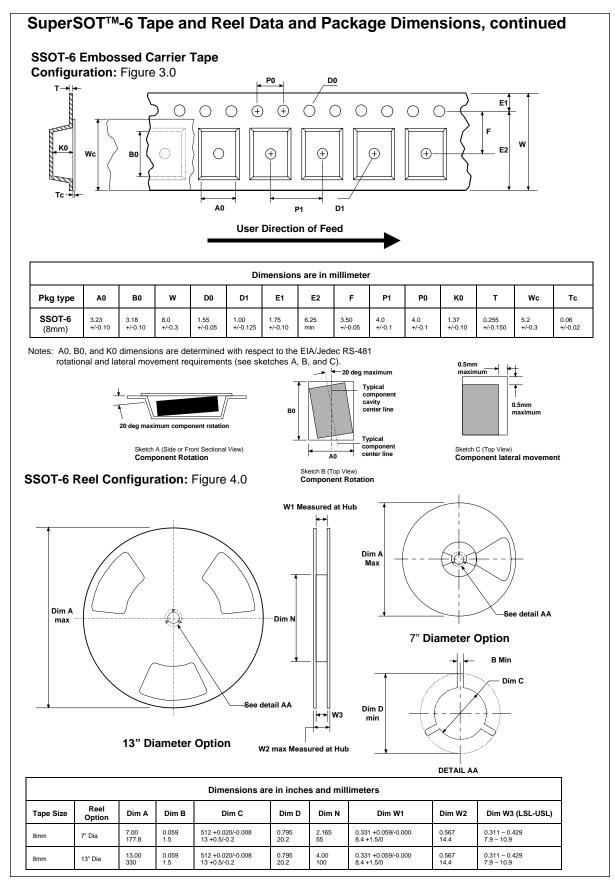
General Description

This device is particularly suited for computer peripheral switching applications where 20V input and 1A output current capability are needed. This load switch integrates a small N-Channel Power MOSFET (Q1) which drives a large P-Channel Power MOSFET (Q2) in one tiny SuperSOT[™]-6 package. A load switch is usually configured for high side switching so that the load can be isolated from

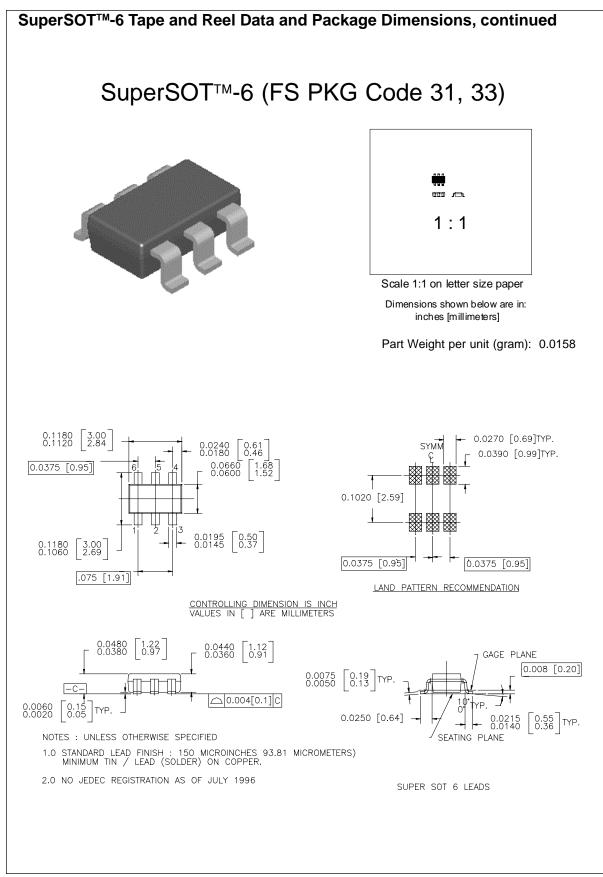
the active power source. A P-Channel Power MOSFET, because it does not require its drive voltage above the input voltage, is usually more cost effective than using an N-Channel device in this particular application. A large P-Channel Power MOSFET minimizes voltage drop. By using a small N-Channel device the driving stage is simplified.



December 1998, Rev. B



December 1998, Rev. B



September 1998, Rev. A

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